



MJ N-Channel Enhancement Mode Power MOSFET

Description

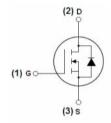
The MJ0110K uses advanced trench technology and design to provide excellent $R_{\text{DS}(\text{ON})}$ with low gate charge. It can be used in a wide variety of applications.

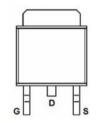
General Features

- V_{DS} =100V,I_D =9.6A R_{DS(ON)} <140mΩ @ V_{GS}=10V (Typ:108mΩ)
- ◆ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high E_{AS}
- ◆ Excellent package for good heat dissipation
- ◆ Special process technology for high ESD capability

Application

- Power switching application
- ◆ Hard switched and high frequency circuits
- ◆ Uninterruptible power supply







Schematic diagram

Marking and pin assignment

TO-252-2L top view

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ0110K	MJ0110K	TO-252-2L	-	-	-

Absolute Maximum Ratings (Tc =25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	100	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	ID	9.6	А
Drain Current-Continuous(Tc =100℃)	I D(100℃)	6.5	А
Pulsed Drain Current	Ірм	38.4	А
Maximum Power Dissipation	PD	30	W
Derating factor		0.2	W/°C
Single pulse avalanche energy (Note 5)	Eas	20	mJ
Operating Junction and Storage Temperature Range	Тл, Т sтg	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	5	°C/W
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Electrical Characteristics (Tc =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·					
Drain-Source Breakdown Voltage	BVpss	V _{GS} =0V I _D =250μA	100	110	-	V
Zero Gate Voltage Drain Current	Ipss	V _{DS} =100V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	VGS(th)	V _{DS} =V _{GS} ,I _D =250µA	1.2	1.8	2.5	V
Drain-Source On-State Resistance	RDS(ON)	V _{GS} =10V, I _D =6A	-	108	140	mΩ
Forward Transconductance	grs	Vps=25V,Ip=6A	3.5	-	-	S
Dynamic Characteristics (Note 4)	·					
Input Capacitance	Clss		-	690	-	PF
Output Capacitance	Coss	V _{DS} =25,V _{GS} =0V F=1.0MHz	-	120	-	PF
Reverse Transfer Capacitance	Crss		-	90	-	PF
Switching Characteristics (Note 4)	'					
Turn-on Delay Time	t _{d(on)}		-	11	-	nS
Turn-on Rise Time	tr	V _{DD} =30V,I _D =2A,R _L =15Ω	-	7.4	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _G =2.5Ω	-	35	-	nS
Turn-Off Fall Time	tr	-	-	9.1	-	nS
Total Gate Charge	Qg		-	15.5	-	nC
Gate-Source Charge	Qgs	V _{DS} =30V,I _D =3A V _{GS} =10V	-	3.2	-	nC
Gate-Drain Charge	Qgd	-	-	4.7	-	nC
Drain-Source Diode Characteristics	I					
Diode Forward Voltage (Note 3)	VsD	V _{GS} =0V,I _S =9.6A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	9.6	А
Reverse Recovery Time	trr	TJ=25°C, IF=9.6A	-	21	-	nS
Reverse Recovery Charge	Qrr	di/dt=100A/µs (Note 3)	-	97	-	nC
Forward Turn-On Time	ton	Intrinsic turn-on time is ne	aliaible(tı	ırn-on is d	ominated h	v I S+I D

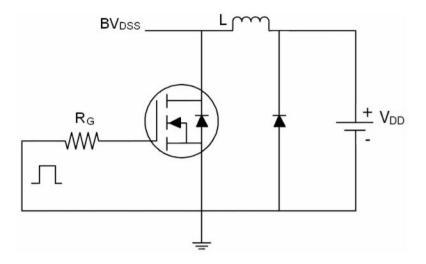
Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- $\ensuremath{\mathfrak{G}}$ Pulse Test: Pulse Width $\leq 300 \mu s$, Duty Cycle $\leq 2\%$.
- 4 Guaranteed by design, not subject to production

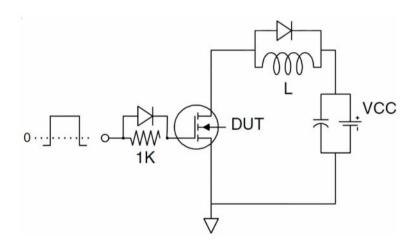




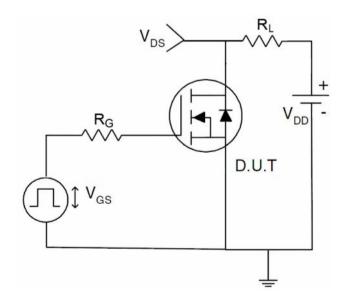
Test circuit



Eas test Circuit



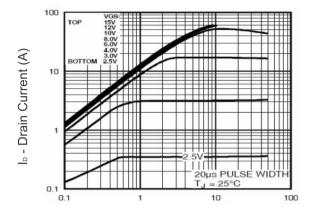
Gate charge test Circuit



Switch Time Test Circuit

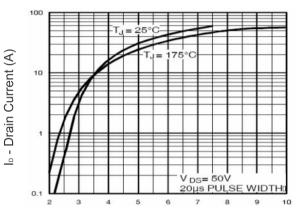


Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics



Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics

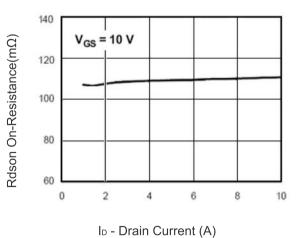
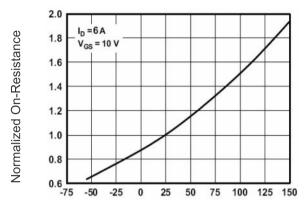
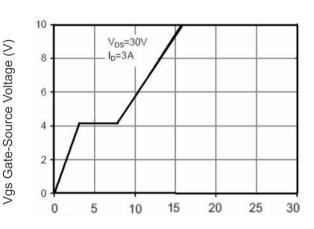


Figure 3 Rdson- Drain Current

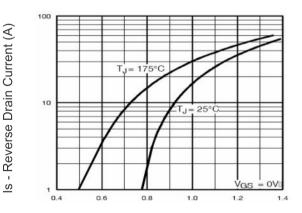


 T_{J} -Junction Temperature(${}^{\circ}\mathsf{C}$)

Figure 4 Rdson-Junction Temperature



Qg Gate Charge (nC)
Figure 5 Gate Charge

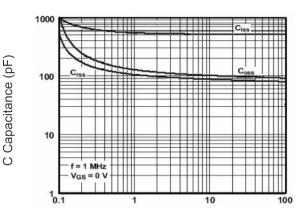


Vsd Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward

BVDSS





Vds Drain-Source Voltage (V) Figure 7 Capacitance vs Vds

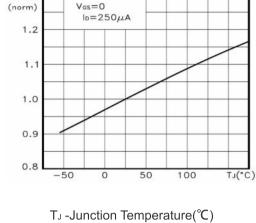
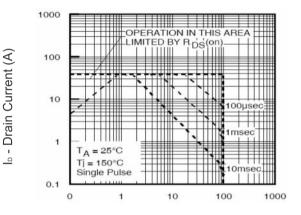
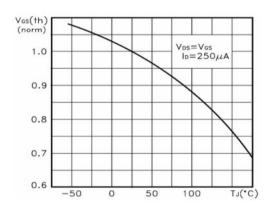


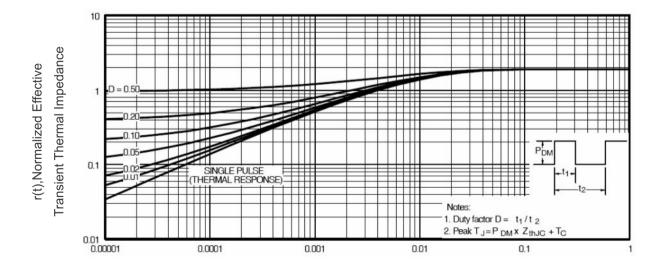
Figure 9 BVpss vs Junction Temperature



Vds Drain-Source Voltage (V) Figure 8 Safe Operation Area



T_J -Junction Temperature(°C) Figure 10 V_{GS(th)} vs Junction Temperature



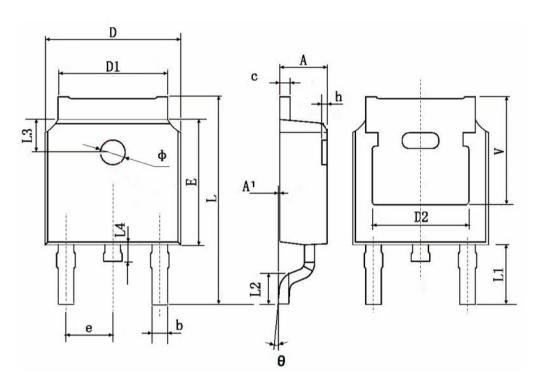
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





TO-252 Package Information



O. mahad	Dimensions	In Millimeters	Dimension	s In Inches
Symbol	Min.	Max.	Min.	Max.
А	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
С	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.8	30 TYP.	0.190	TYP.
E	6.000	6.200	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900	TYP.	0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600	TYP.	0.063	TYP.
L4	0.600	1.000	0.024	0.039
Ф	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 TYP.		0.211	TYP.





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